

PHOTOSENSITIVE COMPOSITION, CURED PRODUCT, DISPLAY DEVICE,
ELECTRONIC COMPONENT, AND METHOD FOR PRODUCING CURED
PRODUCT

ABSTRACT

An object of the present invention is to provide a photosensitive composition of having improved sensitivity at the time of exposure, suppressed narrow mask bias of an opening pattern dimension after development, and excellent halftone characteristics, and a cured film capable of improving reliability of a light-emitting element in a display device and improving migration resistance in an electronic component. In order to achieve the above object, the photosensitive composition of the present invention is a photosensitive composition satisfying a condition (α) or a condition (β) below, wherein a double bond equivalent in total solid content is 600 to 6,000 g/mol: the condition (α): containing a compound of (I) described below and/or a compound of (II) described below: (I) a compound having a specific weakly acidic group (WA) and a radical polymerizable group; and (II) a compound having a specific weakly acidic group (WA) and Compound having a radical polymerizable group; or the condition (β): containing an alkali-soluble resin (A), a radical polymerizable compound (B), and a photosensitive agent (C):

[Figure 3]